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SLM CORP Form 8-K January 20, 2010

UNITED STATES SECURITIES AND EXCHANGE COMMISSION

WASHINGTON, D.C. 20549

FORM 8-K

CURRENT REPORT

Pursuant to Section 13 or 15(d) of the Securities Exchange Act of 1934

Date of Report	(Date of Farliest	Event Reported):	
Date of Report	UZALE OF EATHEST	TAVEIL NEDULEUL.	

January 14, 2010

SLM CORPORATION

(Exact name of registrant as specified in its charter)

Delaware	001-13251	52-2013874
(State or other jurisdiction of incorporation)	(Commission File Number)	(I.R.S. Employer Identification No.)
12061 Bluemont Way, Reston, Virginia		20190
(Address of principal executive offices)		(Zip Code)
Registrant s telephone number, including are	ea code:	(703) 810-3000
	Not Applicable	
Former name	or former address, if changed since	last report
Check the appropriate box below if the Form 8-K filing he following provisions:	is intended to simultaneously satisfy	the filing obligation of the registrant under any of
 Written communications pursuant to Rule 425 under Soliciting material pursuant to Rule 14a-12 under the Pre-commencement communications pursuant to Rule Pre-commencement communications pursuant to Rule 	te Exchange Act (17 CFR 240.14a-12 ule 14d-2(b) under the Exchange Act	2) (17 CFR 240.14d-2(b))

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Top of the Form

Item 1.01 Entry into a Material Definitive Agreement.

- (1) On January 15, 2010, HICA Education Loan Corporation, a subsidiary of SLM Corporation (the "Company"), entered into a lending agreement with the Federal Home Loan Bank Des Moines (FHLB). Advances from the FHLB will be backed by eligible collateral including federally-guaranteed student loans. The amount, price and tenor of advances from the FHLB will vary and will be determined at the time of each borrowing. A \$25 million funding occurred on January 15, 2010 to initiate this relationship.
- (2) On January 15, 2010, the Company terminated its existing asset-backed commercial paper facilities totaling \$10.875 billion and entered into a new multi-year ABCP facility (the "Facility") totaling \$10 billion which will continue to provide funding for the Company's federally-guaranteed student loans. The Facility provides maximum funding of \$10 billion for the first year, \$5 billion for the second year and \$2 billion for the third year. Commitment and other upfront fees were approximately \$4.0 million. The underlying cost of borrowing under the new ABCP conduit facility for the first year is expected to be the commercial paper issuance cost plus 0.50 percent for the FFELP loan facilities, excluding up-front commitment and unused fees.

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Top of the Form

SIGNATURES

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned hereunto duly authorized.

SLM CORPORATION

January 20, 2010 By: /s/ Mark L. Heleen

Name: Mark L. Heleen

Title: Executive Vice President and General Counsel